CRYOQOOL **CPU Cooler for Servers**

Description: Designed for cooling dense 2U applications using CPUs that fit the Intel™ LGA2011 square, LGA2066 (Socket R), and LGA 1366 sockets

Heat Sink Type: Heat Sink with High-Performance Fans Heat Sink Attachment: Hardware Kit - ATS-HK349-R1

Features & Benefits

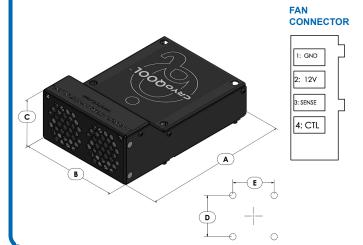
- « Ideal for 2U applications where space and airflow are restricted
- « Designed for CPUs that fit the Intel™ LGA2011 square, LGA2066 (Socket R), and LGA 1366 sockets
- « Mechanical attachment is PEM, screws and spring for other types of attachments contact ATS
- « Provided with Chomerics T670 thermal grease
- « Hardware provides 21 psi of mounting pressure when installed on component in socket LGA2011
- « PWM enabled fans: Voltage 12VDC (10.8 min 12.6 max), Current 1.52A per fan
- « Provides at least 50% improvement over comparable products on the market
- « To apply this heat sink to other high power devices and processors contact ATS
- « ATS cryoQOOL heat sink technology is patent pending



DIMENSION A (LENGTH, mm)				DIMENSION E (MOUNTING HOLE LENGTH, mm)	Fin Material	Finish	Weight (g)	HARDWARE KIT	TIM	LEAD WIRE PIN OUT
137	97.6	47.8	80	80	Copper	None	1,610	ATS-HK349-R1	T670 Thermal Grease	4 Wire

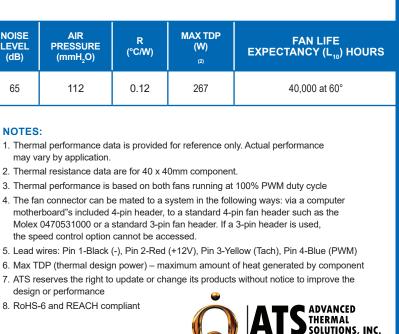
Thermal Performance (3)

FAN RATED VOLTAGE (Vdc)	FAN OPERATING VOLTAGE RANGE (Vdc)	RATED SPEED (RPM)	RATED INPUT POWER (W)	RATED AIRFLOW (CFM)	NOISE LEVEL (dB)	AIR PRESSURE (mmH ₂ O)	R (°C/W)	MAX TDP (W)	FAN LIFE EXPECTANCY (L ₁₀) HOURS
12	10.8 ~ 12.6	25,000	36.6	58.6	65	112	0.12	267	40,000 at 60°



NOTES:

- may vary by application.
- 2. Thermal resistance data are for 40 x 40mm component.
- 3. Thermal performance is based on both fans running at 100% PWM duty cycle
- motherboard"s included 4-pin header, to a standard 4-pin fan header such as the Molex 0470531000 or a standard 3-pin fan header. If a 3-pin header is used, the speed control option cannot be accessed.
- 6. Max TDP (thermal design power) maximum amount of heat generated by component
- 7. ATS reserves the right to update or change its products without notice to improve the design or performance
- 8. RoHS-6 and REACH compliant



Images for illustration

purposes only.

Innovations in Thermal Management®